Minority spin transport in epitaxially grown nickel-iron nitride films

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Abstract

20-60 nm-thick epitaxial Ni_xFe_{4-x}N (x = 0, 1, 3, and 4) films were successfully fabricated on SrTiO₃ (001) singlecrystal substrates by alternating substrate temperature (T_{sub}). Crystal orientation and degree of order of N site were improved with the increase of T_{sub} for x = 1 and 3. The lattice constant and saturation magnetization decreased as the Ni content increased. Curie temperature of the Ni₃FeN film was estimated to be 266 K from the temperature dependence of magnetization. Negative anisotropic magnetoresistance effects were observed for x = 1and 3, and this result indicates that the minority spin conduction is dominant in Ni_xFe_{4-x}N(x = 1 and 3).

1. Introduction

Anti-perovskite type 3d transition metal ferromagnetic nitrides are a promising candidate as a new spintronics material. Fe₄N, one of these compounds, is theoretically predicted to have a large negative spin-polarization of electrical conductivity [1], and negative anisotropic magnetoresistance (AMR) effects originating from the negative spin-polarization of Fe₄N were reported [2]. Ni_xFe_{4-x}N, where Fe atoms are partially replaced with Ni atoms, is theoretically expected to exhibit a larger negative spin-polarization of density of states at Fermi level ($P_D = -0.86$) than Fe₄N, and can be a candidate material for spintronics with a high spin-polarization. According to previous studies, the saturation magnetization (M_s) , lattice constant, and Curie temperature (T_c) of powdered $Ni_xFe_{4-x}N$ ($0 \le x \le 3.6$) monotonically decreased with increasing Ni content [3], and T_c is lower than room temperature (RT) for $x \ge 3$. However, this is not consistent with recent report that Ni₃FeN epitaxial films exhibited a large positive AMR ratio of approximately 6% at RT [4]. Therefore, it is not made clear whether the T_c is above RT or not for Ni₃FeN. In this work, we fabricated 20-60 nm-thick Ni_xFe_{4-x}N (x = 0, 1, 3, and 4) epitaxial films, and examined their magnetic and magnetotransport properties by measuring magnetization curve and AMR effect.

2. Experiment

We grew 20-60 nm thick $Ni_xFe_{4,x}N(x = 0, 1, 3, and 4)$ films on SrTiO₃ (STO) (001) single-crystal substrates by molecular beam epitaxy using solid sources of Ni and/or Fe and radiofrequency (RF) N plasma. Substrate temperature (T_{sub}) was varied from 150 to 550 °C and the Ni/Fe ratio was controlled by their crucible temperatures. The crystalline quality of grown films was evaluated by reflection high-energy electron diffraction (RHEED), ω -2 θ x-ray diffraction (XRD), and ϕ - $2\theta\chi$ XRD measurements with Cu-Ka radiation. Occupation probability of N atom at the body center of Ni_xFe_{4-x}N and the degree of order (S) were evaluated from the integrated intensities of the fundamental Ni_xFe_{4-x}N (200) and super lattice $Ni_xFe_{4-x}N$ (100) peaks from x-ray diffraction patterns. Magnetic measurements were carried out for approximately 60 nm-thick Ni_xFe_{4-x}N films utilizing the vibrating sample magnetometer and superconducting quantum interference device magnetometer. A photolithographic process and ion milling were used to pattern the Al-capped 50 nm-thick $Ni_xFe_{4-x}N(x)$ = 1 and 3) films with stripes 0.2 mm wide and 6 mm long for resistance measurements. The stripes were patterned along the Ni_xFe_{4-x}N (x = 1 and 3) [100] and [110] direction. The AMR measurements were performed in the temperature range of 5-300 K, by a DC four-probe method using the external magnetic field of 30 kOe, and the electric current of 0.2 mA.

3. Result and discussion

Fig. 1 shows the ω -2 θ XRD and RHEED patterns of 20 nmthick Ni_xFe_{4-x}N(x = 0, 1, 3, and 4) films fabricated at $T_{sub} =$ 450, 550, 350, and 250 °C, respectively. Only (001) oriented diffraction peak and streaky RHEED patterns were observed for x = 0, 1, and 3, which is indicative of epitaxial growth of single-phase nitrides. In the case of Ni₄N, however, other phases such as Ni₈N were confirmed, suggesting the decomposition due to release of N atoms. The full width at half maximums (FWHMs) for NiFe₃N(002) and Ni₃FeN(002) diffraction lines, measured by x-ray ω -scan rocking curves decreased with increasing T_{sub} and showed the smallest values of FWHM = 0.280 and 1.248° at T_{sub} = 550 and 400 °C, respectively. In addition, the S of NiFe₃N and Ni₃FeN reached the largest values of S = 0.71 and 0.75 at the respective T_{sub} . The S value was calculated to be 0.75 for Fe₄N fabricated at $T_{\rm sub} = 450$ °C, whereas we were not able to calculate it for Ni₄N because of its supper lattice diffraction peak being very weak. The lattice constants of $Ni_xFe_{4-x}N(x = 0, 1, 3, and 4)$ films were determined to be 3.798, 3.790, 3.756, and 3.745 Å,

respectively. The decrease of lattice constants with increasing x in Ni_xFe_{4-x}N is well explained by the replacement of Fe atoms with smaller radius Ni atoms.

Fig. 2 shows the M_s of Ni_xFe_{4-x}N films as a function of x. Those obtained from first-principle calculation are also plotted. The M_s values were 1300 ± 70 emu/cm³ and 1060 ± 50 emu/cm³ for Fe₄N and NiFe₃N, respectively, at RT, and they increased to 1520 ± 80 emu/cm³, 1150 ± 60 emu/cm³ at 2 K. In contrast, the hysteresis curve was not obtained for Ni₃FeN at RT but obtained at 2 K with $M_s = 480 \pm 20$ emu/cm³. T_c of Ni₃FeN film was determined to be 266 K from the temperature dependence of magnetization. In our present experimental result, Ni₄N was paramagnetic, differently from our first-principle calculation.

Fig. 3 shows the temperature dependence of AMR ratio of $Ni_xFe_{4,x}N(x = 1 \text{ and } 3)$ films. The AMR ratios of $NiFe_3N$ (Ni_3FeN) at 5 K were -1.0% (-1.6%) and -0.5% (-4.0%) in I // [100] and I // [110] directions, respectively. Negative AMR ratio was obtained at almost all of the temperature. According to recent theory of Kokado *et al.* in the framework of the two-current model that takes into account the *s*-*d* scattering, negative AMR effect is explained by scattering process of $s_{\uparrow} \rightarrow d_{\uparrow}$ or $s_{\downarrow} \rightarrow d_{\downarrow}$ [5]. It is understood that P_D of $Ni_xFe_{4,x}N(x = 1 \text{ and } 3)$ are negative, therefore, these negative AMR effects are originated from scattering process of $s_{\downarrow} \rightarrow d_{\downarrow}$, and indicates that the minority spin transport is dominant in $Ni_xFe_{4,x}N(x = 1 \text{ and } 3)$.

4. Conclusion

Ni_xFe_{4-x}N(x = 0, 1, 3, and 4) epitaxial films were successfully prepared on STO(001) single-crystal substrates and their crystalline qualities, magnetic properties, and magneotransport properties were investigated. The crystal orientation and *S* values were evaluated for samples grown at various T_{sub} . With increasing T_{sub} , the FWHMs of NiFe₃N(002) and Ni₃FeN(002) diffraction lines decreased and they reached the smallest values of 0.28 and 1.248° at $T_{sub} = 550$ and 400 °C, respectively, and their *S* values reached the highest values of 0.71 and 0.75. The lattice parameters and M_s decreased for Ni_xFe_{4-x}N as the Ni composition increased. Negative AMR effects were observed for x = 1 and 3, indicating that the minority spin electron dominate the electrical conductivity in Ni_xFe_{4-x}N(x = 1 and 3).

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Fig. 1 ω -2 θ XRD and RHEED patterns of 20 nm-thick Ni_xFe_{4-x}N (x = 0, 1, 3, and 4) films.



Fig. 2 Saturation magnetization of $Ni_xFe_{4-x}N(x = 0, 1, 3, and 4)$.



Fig. 3 Temperature dependence of AMR ratio of $Ni_xFe_{4-x}N(x = 1 \text{ and } 3)$.